IEEE P802.3bs 400 Gb/s Ethernet Task Force Informal Communication

Source: IEEE P802.3bs 400 Gb/s Ethernet Task Force1

> Rapporteur, ITU-T Q11/15 Mark Jones

Mark.Jones@xtera.com

Rapporteur, ITU-T Q6/15 To: Peter Stassar Peter.Stassar@huawei.com

Chairman, ITU-T Study Group 15

Steve Trowbridge steve.trowbridge@alcatel-lucent.com

Chair, IEEE 802 LMSC Paul Nikolich

p.nikolich@ieee.org

Chair, IEEE 802.3 Ethernet Working Group David Law

dlaw@hp.com

Vice-chair, IEEE 802.3 Ethernet Working Group Adam Healey

adam.healey@avagotech.com

Secretary, IEEE 802.3 Ethernet Working Group Pete Anslow

panslow@ciena.com

Chair, IEEE P802.3bs 400 Gb/s Ethernet Task Force From: John D'Ambrosia

John DAmbrosia@dell.com

Informal communication to ITU-T Study Group 15 on progress in IEEE P802.3bs Subject:

400 Gb/s Ethernet Task Force

Agreed to at IEEE P802.3bs 400 Gb/s Ethernet Task Force meeting, Atlanta, GA, Approval:

16 January 2015

CC:

Dear Mr. Trowbridge and members of ITU-T Study Group 15,

For your information, the baseline proposals adopted so far in the P802.3bs project include the following:

Baseline adopted in San Diego meeting (July 2014):

 Adopt the baseline for the CDMII logical interface as shown in slide 5 of gustlin 3bs 03 0714.pdf

Baselines adopted in Kanata, Canada meeting (September 2014):

 Adopt 16 x 25Gb/s and 8 x 50Gb/s as the basis for the lane rates for any optional C2C and C2M electrical interfaces

¹ This document solely represents the views of the IEEE P802.3bs 400 Gb/s Ethernet Task Force, and does not necessarily represent a position of the IEEE, the IEEE Standards Association, IEEE 802 or the IEEE 802.3 Working Group

 Adopt the P802.3bm C2C and C2M specifications with current values (except that the BER requirement is TBD) as a baseline draft for the 16 x 25Gb/s electrical interfaces

Baselines adopted in San Antonio, TX meeting (November, 2014):

 Adopt the proposal in slides 6 to 16 in king 3bs 02a 1114.pdf as the baseline proposal for the P802.3bs objective to "provide physical layer specifications which support link distances of at least 100 m of MMF" (400GBASE-SR16)

Baselines adopted in Atlanta, GA meeting (January 2015):

- Adopt slides 4 and 8 from <u>dambrosia 02b 0115.pdf</u> as baseline architecture
- Adopt the EEE baseline proposed in <u>marris 3bs 01 0115.pdf</u> slide 7
- Adopt slide 10 of <u>trowbridge 3bs 01a 0115.pdf</u> as the baseline for the OTN mapping reference point
- Adopt the following equation as the informative insertion loss equation for CDAU-8 chipto-chip electrical I/O interface: IL≤{1.083+2.543 SQROOT(f)+0.761f 0.01≤f≤28.05GHz} dB
- Adopt the following equation as the informative insertion loss equation for CDAUI-8 chipto-module electrical I/O interface: IL≤{1.076(0.075+0.537SQROOT(f)+0.566f)}
 0.01≤f≤28.05GHz} dB

Action items have been identified to be worked prior to the next meeting with a view toward being able to adopt remaining logic (e.g., PCS, FEC), electrical, and optical interface baselines.

The information from our most recent meeting is available at: http://ieee802.org/3/bs/public/15 01/index.shtml

Sincerely,

John D'Ambrosia
Chair, IEEE P802.3bs 400 Gb/s Ethernet Task Force
John DAmbrosia@dell.com